



CMOS 4-Channel Analog Multiplexer/Demultiplexer

1 FEATURES

- -3dB Bandwidth: 180MHz
- Single Supply Operation: +2.5V to +5.5V
- Low ON Resistance: 24Ω(TYP) With 5V Supply
- High Off-Isolation: -77dB (R_L = 50Ω, f = 1MHz)
- Break-Before-Make Switching
- Binary Address Decoding on Chip
- Operating Temperature Range:
 -40°C to +125°C
- PACKAGES: MSOP10

2 APPLICATIONS

- Sensors
- Analog and Digital Multiplexing and Demultiplexing
- A/D and D/A Conversion
- Signal Gating
- Battery-Operated Equipment
- Factory Automation
- Appliances
- Communications Circuits

3 DESCRIPTIONS

The RS2255 is a CMOS analog IC configured as 4-channel multiplexers. This CMOS device can operate from 2.5 V to 5.5 V.

The RS2255 device are digitally-controlled analog switches. It has low on-resistance (24 Ω TYP) and very low off-leakage current (1nA TYP).

The RS2255 is available in Green MSOP10 packages. It operates over an ambient temperature range of -40°C to +125°C.

Device Information (1)

PART NUMBER	PACKAGE	BODY SIZE (NOM)
RS2255	MSOP10	3.00mm×3.00mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.

4 Functional Diagrams of RS2255

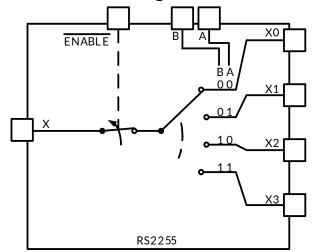




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5 Revision History

Note: Page numbers for previous revisions may different from page numbers in the current version.

VERSION	Change Date	Change Item
C.4	2021/11/25	official version datasheet
C.5	2023/12/21	1.Added the TAPE AND REEL INFORMATION 2.Added MSL on Page 4@RevC.4 3.Update PIN DESCRIPTION on Page 2@RevC.4 4.Update ELECTRICAL CHARACTERISTICS
C.5.1	2024/03/08	Modify packaging naming



6 PACKAGE/ORDERING INFORMATION (1)

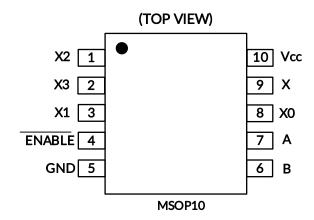
PRODUCT	ORDERING NUMBER	TEMPERATURE RANGE	PACKAGE LEAD	PACKAGE MARKING (2)	MSL (3)	PACKAGE OPTION	
RS2255	RS2255XN	-40°C ~+125°C	MSOP10	RS2255	MSL3	Tape and Reel,4000	

NOTE:

- (1) This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the right-hand navigation.
- (2) There may be additional marking, which relates to the lot trace code information (data code and vendor code), the logo or the environmental category on the device.
- (3) MSL, The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications.



7 PIN CONFIGURATIONS



PIN DESCRIPTION

NAME	PIN	FUNCTION
NAME	MSOP10	FUNCTION
X2	1	Analog Switch Normally Open Input or Output 2.
Х3	2	Analog Switch Normally Open Input or Output 3.
X1	3	Analog Switch Normally Open Input or Output 1.
ENABLE	4	Inhibit. Drive ENABLE low or connect to GND for normal operation. Drive ENABLE high or connect to Vcc to turn all switches off.
GND	5	Ground.
В	6	Digital Address "B" Input.
Α	7	Digital Address "A" Input.
X0	8	Analog Switch Normally Open Input or Output 0.
Х	9	Analog Switch Common Input or Output.
Vcc	10	Positive Analog and Digital Supply Voltage.

FUNCTION TABLE

ENADLE INDUT	INPUT	STATES	ON CHANNIEL (C)
ENABLE INPUT	В	Α	ON CHANNEL(S)
1	Х	Х	NONE
0	0	0	XO
0	0	1	X1
0	1	0	X2
0	1	1	X3

X=Don't care

NOTE: Input and output pins are identical and inter-changeable. Either may be considered an input or output; signals pass equally well in either direction.



8 SPECIFICATIONS

8.1 Absolute Maximum Ratings

Over operating free-air temperature range (unless otherwise noted) (1)

SYMBOL		PARAMETER			MAX	UNIT
Vcc	Supply Voltage			-0.3	6	V
VIN	Input Voltage (All input	s)		-0.3	Vcc+0.3	\ \
l _{IN}	Switch Input Current	Any one input		-20	+20	A
IPEAK	Peak Switch Current	Pulsed at 1ms Duration,	Pulsed at 1ms Duration, <10% Duty Cycle		+40	mA
θја	Package thermal imped	ance ⁽²⁾	MSOP10		200	°C/W
Τ _J	Junction Temperature (3)		-40	150	°C
T _{stg}	Storage temperature			-65	+150]

⁽¹⁾ Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.

- (2) The package thermal impedance is calculated in accordance with JESD-51.
- (3) The maximum power dissipation is a function of $T_{J(MAX)}$, $R_{\theta JA}$, and T_A . The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(MAX)} T_A) / R_{\theta JA}$. All numbers apply for packages soldered directly onto a PCB.

8.2 ESD Ratings

The following ESD information is provided for handling of ESD-sensitive devices in an ESD protected area only.

			VALUE	UNIT
V.	Electrostatic discharge	Human-body model (HBM)	±4500	V
V _(ESD) Ele		Charged-device model (CDM)	±1500	V



ESD SENSITIVITY CAUTION

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

8.3 Recommended Operating Conditions

Over operating free-air temperature range (unless otherwise noted)

SYMBOL	PARAMETER	MIN	MAX	UNIT
V_{CC}	Supply Voltage	2.5	5.5	V
T_A	Operating temperature	-40	+125	°C



8.4 ELECTRICAL CHARACTERISTICS

 $V_{CC} = 5.0 \text{ V or } 3.3 \text{V}$, FULL= -40°C to +125°C, Typical values are at $T_A = +25$ °C. (unless otherwise noted)

PARAMETER	SYMBOL	CONDITIONS	Vcc	TA	MIN ⁽²⁾	TYP (3)	MAX ⁽²⁾	UNIT
ANALOG SWITCH					•			
Analog Signal Range	V _{X_} , V _X			FULL	0		Vcc	٧
0. 0. 1.		\/	5) (+25°C		24	30	Ω
	D	V_{CC} =5V, I_X =1mA	5V	FULL			35	Ω
On-Resistance	+25	+25°C		50	60	Ω		
		V_{CC} =3.3 V , I_X =1 mA	3.3V	FULL			65	Ω
On-Resistance Match	5 0	V 5V 4 A 6 1 1 ON	5) (+25°C		1	4	Ω
Between Channels		V _{CC} =5V, I _X =1mA Switch ON	5V	FULL			5.3	Ω
On-Resistance	R _{FLAT} (ON)	V _{CC} =5V, I _X =1mA Switch ON	E) (+25°C		8	11	Ω
Flatness			5V	FULL			14	Ω
X_ Off, X Off, X On,	I _{x_(OFF)} , I _{x(OFF)} , I _{x(ON)}	V _{CC} =5V, V _X =1V, 4.5V V _X =4.5V, 1V	5V	+25°C		1	100	nA
Leakage Current		V _{CC} =3.3V, V _X _=1V, 3V V _X =3V, 1V	3.3V	+25°C		1	100	nA
DIGITAL CONTROL IN	NPUTS (1)							
Logic Input Logic	V _{AH} , V _{BH} ,		5V	+25°C	1.7			٧
Threshold High	$V_{\overline{ENABLE}}$		3.3V	+25°C	1.7			٧
Logic Input Logic	$V_{AL}, V_{BL},$		5V	+25°C			0.5	V
Threshold Low	$V_{\overline{ENABLE}}$		3.3V	+25°C			0.5	٧
Input-Current High	I _{ah} , I _{bh} , I _{enable}	V_A , V_B , $V_{\overline{ENABLE}} = V_{CC}$	3.3V to 5V	+25°C		1	100	nA
Input-Current Low	I _{al} , I _{bl} , I _{enable}	V _A , V _B , V _{ENABLE} = 0V	3.3V to 5V	+25°C		1	100	nA

⁽¹⁾ All unused digital inputs of the device must be held at VIO or GND to ensure proper device operation.

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⁽²⁾ Limits are 100% production tested at 25°C. Limits over the operating temperature range are ensured through correlations using statistical quality control (SQC) method.

⁽³⁾ Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration.



ELECTRICAL CHARACTERISTICS (continued)Vcc = 5.0 V or 3.3V, FULL= -40°C to +125°C, Typical values are at T_A = +25°C. (unless otherwise noted)

PARAMETER	SYMBOL	CONDITIONS	Vcc	TA	MIN	TYP	MAX	UNIT
DYNAMIC CHARACTERISTICS								
A.I.I. T T.		V_{X} = 3V/0V, R_L = 300 Ω , C_L = 35pF, See Figure 2	5V	+25°C		160		ns
Address Transition Time	ttrans	V_{X} = 3V/0V, R_L = 300 Ω , C_L = 35pF, See Figure 2	3.3V	+25°C		240		ns
ENABLE Turn-On Time	4	$V_{X_{-}} = 3V$, $R_{L} = 300\Omega$, $C_{L} = 35pF$,	5V	+25°C		90		nc
ENABLE Turn-On Time	t _{ON}	See Figure 3	3.3V	+25°C		140		ns
ENABLE Turn-Off Time	toff	$V_{X_{-}} = 3V, R_{L} = 300\Omega, C_{L} = 35pF,$	5V	+25°C		70		nc
ENABLE Turn-Off Time	LOFF	See Figure 3	3.3V	+25°C		100		ns
Break-Before-Make Time	4_	$V_{X_{-}} = 3V, R_L = 300\Omega, C_L = 35pF,$	5V	+25°C		50		ns
Delay	t _D	See Figure 4	3.3V	+25°C		80		ns
Charge Injection		$R_S = 0\Omega$, $C_L = 1$ nF, See Figure 5	5V	10500		6		рC
Charge Injection	Q	$R_S = 0\Omega$, $C_L = 1$ nF, See Figure 5	3.3V	+25°C		4		рC
Off Isolation	Oiso	R_L = 50 Ω , f = 1MHz, See Figure 6	5V	+25°C		-77		dB
-3dB Bandwidth	DIA	D 500	5V	+25°C		180		MHz
-3dB Bandwidth	BW	$R_L = 50\Omega$	3.3V	+25°C		180		MHz
Input Off-Capacitance	C _{X_(OFF)}	f = 1MHz, See Figure 7	5V	+25°C		5		рF
Output Off-Capacitance	C _{X(OFF)}	f = 1MHz, See Figure 7	5V	+25°C		13		рF
Output On- Capacitance	C _{X(ON)}	f = 1MHz, See Figure 7	5V	+25°C		20		pF
Total Harmonic Distortion	THD	$R_L = 600\Omega,5V_{P-P}, f = 20Hz \text{ to } 20kHz$	5V	+25°C		0.7		%
POWER REQUIREMENTS								
Power Supply Range	Vcc			FULL	2.5		5.5	٧
Dower Comply Company		$V_{CC} = 5.0V$, V_A , V_B , $V_{\overline{ENABLE}} = V_{CC}$ or 0	5V	+25°C		0.001	2	uA
Power Supply Current	Icc	V_{CC} = 3.3V, V_A , V_B , $V_{\overline{ENABLE}}$ = V_{CC} or 0	3.3V	+25°C		0.001	1	uA



8.5 TYPICAL CHARACTERISTICS

NOTE: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only.

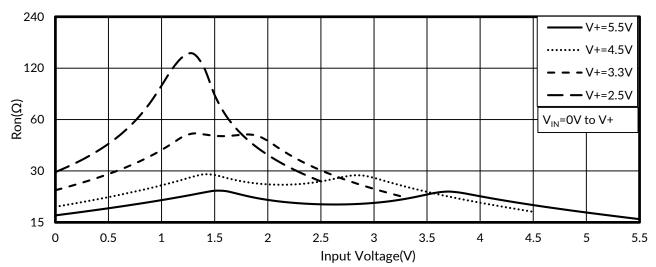


Figure 1. Typical Ron as a Function of Input Voltage



9 Parameter Measurement Information

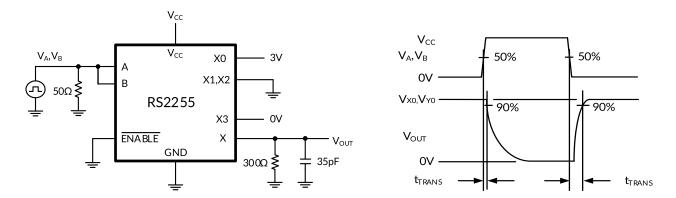


Figure 2. Address Transition Times (ttrans)

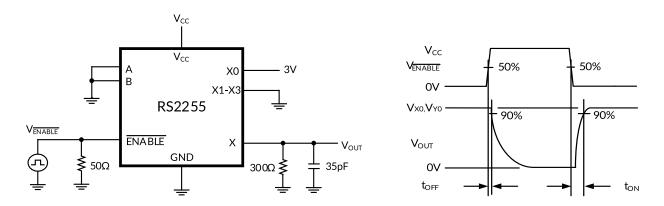


Figure 3. Switching Times (ton, toff)

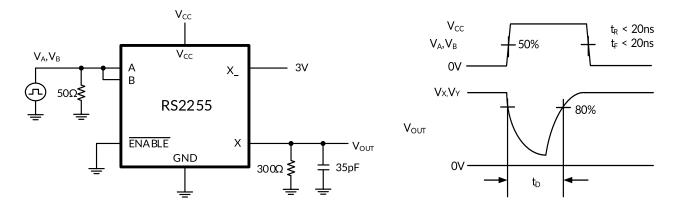


Figure 4. Break-Before-Make Time Delay (t_D)



Parameter Measurement Information (continued)

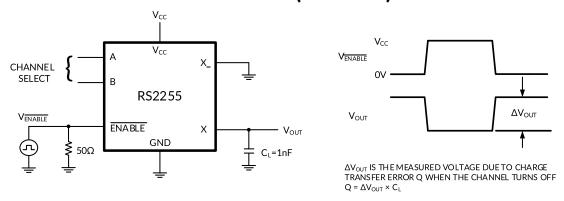
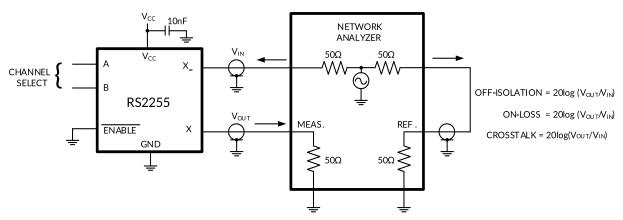


Figure 5. Charge Injection (Q)



MEASUREMENTS ARE STANDARDIZED AGAINST SHORT AT SOCKET TERMINALS .

OFF-ISOLATION IS MEASURED BETWEEN COM AND "OFF" NO TERMINAL ON EACH SWITCH .

ON-LOSS IS MEASURED BETWEEN COM AND "ON" NO TERMINAL ON EACH SWITCH .

SIGNAL DIRECTION THROUGH SWITCH IS REVERSED ; WORST VALUES ARE RECORDED .

Figure 6. Off Isolation, On Loss

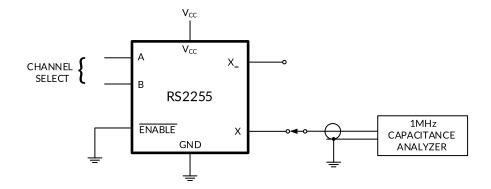
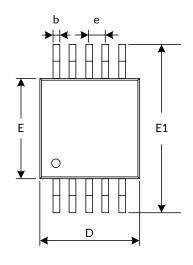
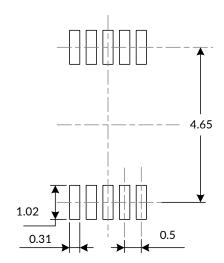


Figure 7. Capacitance

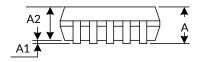


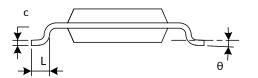
10 PACKAGE OUTLINE DIMENSIONS MSOP10 (3)





RECOMMENDED LAND PATTERN (Unit: mm)





Cl I	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
A ⁽¹⁾	0.820	1.100	0.032	0.043	
A1	0.020	0.150	0.001	0.006	
A2	0.750	0.950	0.030	0.037	
b	0.180	0.280	0.007	0.011	
С	0.090	0.230	0.004	0.009	
D ⁽¹⁾	2.900	3.100	0.114	0.122	
е	0.50(BSC) (2)		0.020(BSC) ⁽²⁾	
E (1)	2.900	3.100	0.114	0.122	
E1	4.750	5.050	0.187	0.199	
L	0.400	0.800	0.016	0.031	
θ	0°	6°	0°	6°	

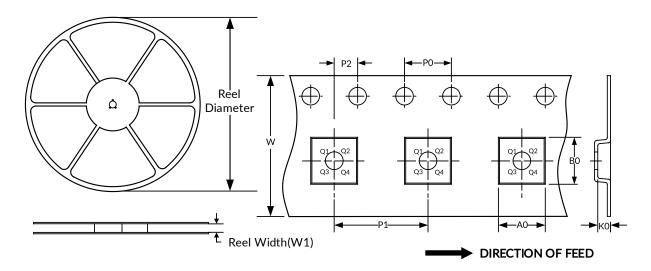
NOTE:

- Plastic or metal protrusions of 0.15mm maximum per side are not included.
 BSC (Basic Spacing between Centers), "Basic" spacing is nominal.
 This drawing is subject to change without notice.



11 TAPE AND REEL INFORMATION REEL DIMENSIONS

TAPE DIMENSION



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width(mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
MSOP10	13"	12.4	5.20	3.30	1.20	4.0	8.0	2.0	12.0	Q1

NOTE:

- 1. All dimensions are nominal.
- 2. Plastic or metal protrusions of 0.15mm maximum per side are not included.



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